

ISL28290

Dual Single Supply Ultra-Low Noise, Ultra-Low Distortion, Rail-to-Rail Output, Op Amp

The ISL28290 is a dual ultra-low noise, ultra-low distortion operational amplifiers. Fully specified to operate down to +3V single supply. The amplifier has outputs that swing rail-to-rail, and an input common mode voltage that extends below ground (ground sensing).

The ISL28290 is unity gain stable with an input referred voltage noise of 1nV/ $\sqrt{\text{Hz}}$. The part features 0.00017% THD+N at 1kHz.

The ISL28290 is available in the 10 Ld UTQFN (1.8mmx1.4mm), 10 Ld MSOP and 8 LD SOIC packages. Device operation is guaranteed over -40°C to +125°C.

Related Information

For a full list of related documents, visit our website:

- [ISL28290 device page](#)

Features

- 1nV/ $\sqrt{\text{Hz}}$ input voltage noise
- 1kHz THD+N typical 0.00017% at 2V_{P-P} V_{OUT}
- Harmonic Distortion -87dBc, -90dBc, f_O = 1MHz
- 170MHz -3dB bandwidth
- 50V/ μs slew rate
- 700 μV maximum offset voltage
- 10 μA typical input bias current
- 103dB typical CMRR
- 3V to 5.5V single supply voltage range
- Rail-to-rail output
- Ground sensing
- Enable pin (not available in the 8 Ld SOIC package option)
- Pb-free (RoHS compliant)

Applications

- Low noise signal processing
- Low noise microphones/preamplifiers
- ADC buffers
- DAC output amplifiers
- Digital scales
- Strain gauges/sensor amplifiers
- Radio systems
- Portable equipment
- Infrared detectors

Contents

| | |
|---|----|
| 1. Overview | 3 |
| 1.1 Ordering Information | 3 |
| 2. Pin Information | 4 |
| 2.1 Pin Configuration | 4 |
| 2.2 Pin Descriptions | 4 |
| 3. Specifications | 6 |
| 3.1 Absolute Maximum Ratings | 6 |
| 3.2 Thermal Information | 6 |
| 3.3 Recommended Operation Conditions | 6 |
| 3.4 Electrical Specifications | 7 |
| 4. Typical Performance Curves | 10 |
| 5. Applications Information | 15 |
| 5.1 Product Description | 15 |
| 5.2 Enable/Power-Down | 15 |
| 5.3 Input Protection | 15 |
| 5.4 Using Only One Channel | 15 |
| 5.5 Power Supply Bypassing and Printed Circuit Board Layout | 16 |
| 5.6 Current Limiting | 16 |
| 5.7 Power Dissipation | 16 |
| 6. Revision History | 17 |
| 7. Package Outline Drawings | 18 |

1. Overview

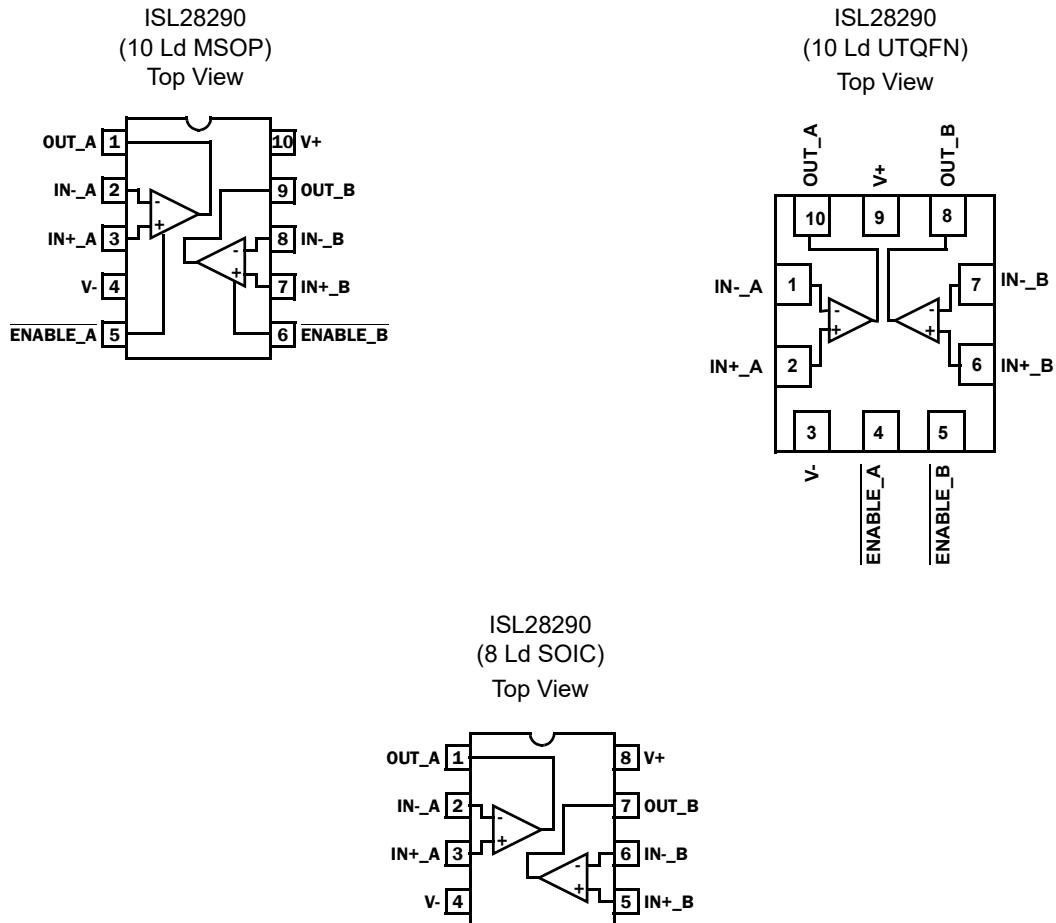
1.1 Ordering Information

| Part Number | Part ^[1] Marking | Temp Range (°C) | Tape and Reel ^[2] (Units) | Package (RoHS Compliant) | Pkg. Dwg. # |
|-----------------|-----------------------------|-----------------|--------------------------------------|--------------------------|--------------|
| ISL28290FUZ | 8290Z | -40 to +125 | | 10 Ld MSOP | M10.118A |
| ISL28290FUZ-T7 | 8290Z | -40 to +125 | 1.5k | 10 Ld MSOP | M10.118A |
| ISL28290FRUZ-T7 | E | -40 to +125 | 3k | 10 Ld UTQFN | L10.1.8x1.4A |
| ISL28290FBZ | 28290 FBZ | -40 to +125 | | 8 Ld SOIC | M8.15E |
| ISL28290FBZ-T7 | 28290 FBZ | -40 to +125 | 1k | 8 Ld SOIC | M8.15E |
| ISL28290EVAL1Z | Evaluation Board | | | | |

1. The part marking is located on the bottom of the part.
2. See TB347 for details about reel specifications.

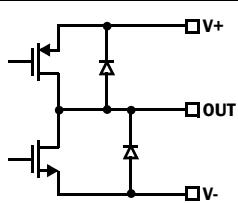
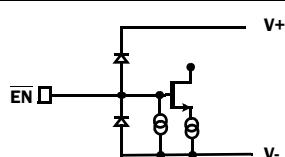
2. Pin Information

2.1 Pin Configuration



2.2 Pin Descriptions

| ISL28290 (10 Ld MSOP) | ISL28290 (10 Ld UTQFN) | ISL28290 (8 Ld SOIC) | Pin Name | Function | Equivalent Circuit |
|--------------------------|---------------------------|-------------------------|-----------------------|---------------------|---|
| 2 (A) 8 (B) | 1 (A) 7 (B) | 2 (A) 6 (B) | IN- IN-_A IN-_B | Inverting input | <p>Circuit 1</p> <p>This circuit diagram illustrates the inverting input stage. It features a differential pair with two NPN transistors. The non-inverting input (IN+) is connected to the base of the upper transistor. The inverting input (IN-) is connected to the collector of the upper transistor and to the base of the lower transistor via a resistor. The collector of the lower transistor is connected to the output (OUT_A) and to the negative supply (V-). The emitters of both transistors are connected to ground.</p> |
| 3 (A) 7 (B) | 2 (A) 6 (B) | 3 (A) 5 (B) | IN+ IN+_A IN+_B | Non-inverting input | (See Circuit 1) |
| 4 | 3 | 4 | V- | Negative supply | |

| ISL28290 (10 Ld MSOP) | ISL28290 (10 Ld UTQFN) | ISL28290 (8 Ld SOIC) | Pin Name | Function | Equivalent Circuit |
|--------------------------|---------------------------|-------------------------|-----------------------|---|--|
| 1 (A) 9 (B) | 10 (A) 8 (B) | 1 (A) 7 (B) | OUT OUT_A OUT_B | Output |  <p>Circuit 2</p> |
| 10 | 9 | 8 | V+ | Positive supply | |
| 5 (A) 6 (B) | 4 (A) 5 (B) | N/A | EN EN_A EN_B | Enable BAR pin internal pull-down; Logic "1" selects the disabled state; Logic "0" selects the enabled state. |  <p>Circuit 3</p> |

3. Specifications

3.1 Absolute Maximum Ratings

| Parameter | Minimum | Maximum | Unit |
|---|----------|----------|------------|
| Supply Voltage | | 5.5 | mA |
| Supply Turn-On Voltage Slew Rate | | 1 | V/ μ s |
| Differential Input Current | | 5 | mA |
| Differential Input Voltage | | 0.5 | V |
| Input Voltage | V- - 0.5 | V+ + 0.5 | V |
| ESD Rating | Value | | Unit |
| Human Body Model (Tested per JS-001-2017) | 3 | | kV |
| Machine Model | 300 | | V |
| Charged Device Model (Tested per JS-002-2014) | 1200 | | V |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions can adversely impact product reliability and result in failures not covered by warranty.

3.2 Thermal Information

| Thermal Resistance (Typical) ^{[1] [2] [3] [4]} | θ_{JA} (°C/W) | θ_{JC} (°C/W) |
|---|----------------------|----------------------|
| 8 Ld SOIC Package | 110 | 82 |
| 10 Ld MSOP Package | 175 | 90 |
| 10 Ld UTQFN Package | 190 | 140 |

1. θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief [TB379](#) for details.
2. θ_{JA} is measured in free air with the component mounted on a high effective thermal conductivity test board with direct attach features. See Tech Brief [TB379](#).
3. For θ_{JC} , the case temperature location is the center of the exposed metal pad on the package underside.
4. For θ_{JC} , the case temperature location is taken at the package top center.

| Parameter | Minimum | Maximum | Unit |
|-----------------------------------|-----------|---------|------|
| Maximum Junction Temperature | | +125 | °C |
| Maximum Storage Temperature Range | -65 | +150 | °C |
| Pb-Free Reflow Profile | see TB493 | | |

3.3 Recommended Operation Conditions

| Parameter | Minimum | Maximum | Unit |
|---------------------|---------|---------|------|
| Supply Voltage | | 5.0 | V |
| Ambient Temperature | -40 | +125 | °C |

3.4 Electrical Specifications

$V+ = 5.0V$, $V- = GND$, $R_L = \text{Open}$, $R_F = 1k\Omega$, $A_V = -1$ unless otherwise specified. Parameters are per amplifier. Typical values are at $V+ = 5V$, $T_A = +25^\circ C$. Boldface limits apply over the operating temperature range, $-40^\circ C$ to $+125^\circ C$, temperature data established by characterization.

| Parameter | Symbol | Test Conditions | Min ^[1] | Typ | Max ^[1] | Unit | |
|-------------------------------------|----------------------------------|---|--------------------|------------|--------------------|------------------|--|
| DC Specifications | | | | | | | |
| Input Offset Voltage | V_{OS} | | -1100 | 240 | 700 | μV | |
| | | | | | 900 | | |
| Input Offset Drift vs Temperature | $\frac{\Delta V_{OS}}{\Delta T}$ | See Figure 21 | | 1.9 | | $\mu V/^\circ C$ | |
| Input Offset Current | I_{IO} | | 40 | 500 | | nA | |
| | | | | 900 | | | |
| Input Bias Current | I_B | | 10 | 16 | | μA | |
| | | | | 18 | | | |
| Common-Mode Voltage Range | V_{CM} | | 0 | | 3.8 | V | |
| Common-Mode Rejection Ratio | CMRR | $V_{CM} = 0V$ to $3.8V$ | 78 | 103 | | dB | |
| Power Supply Rejection Ratio | PSRR | $V_S = 3V$ to $5V$ | 74 | 80 | | dB | |
| Large Signal Voltage Gain | A_{VOL} | $V_O = 0.5V$ to $4V$, $R_L = 1k\Omega$ | 94 | 102 | | dB | |
| | | | 90 | | | | |
| Maximum Output Voltage Swing | V_{OUT} | Output low, $R_L = 1k\Omega$ | | 20 | 50 | mV | |
| | | Output high, $R_L = 1k\Omega$, $V+ = 5V$ | 4.95 | 4.97 | | | |
| | | | 4.92 | | | V | |
| | | | | | | | |
| Supply Current per Channel, Enabled | $I_{S,ON}$ | | 8.5 | 11 | | mA | |
| | | | | 13 | | | |
| Supply Current, Disabled | $I_{S,OFF}$ | | 26 | 35 | | μA | |
| | | | | 52 | | | |
| Short-Circuit Output Current | I_{O^+} | $R_L = 10\Omega$ | 95 | 144 | | mA | |
| | | | 90 | | | | |

V₊ = 5.0V, V₋ = GND, R_L = Open, R_F = 1kΩ, A_V = -1 unless otherwise specified. Parameters are per amplifier. Typical values are at V₊ = 5V, T_A = +25°C. Boldface limits apply over the operating temperature range, -40°C to +125°C, temperature data established by characterization.(Cont.)

| Parameter | Symbol | Test Conditions | Min ^[1] | Typ | Max ^[1] | Unit |
|---|--|--|--------------------|-------------|--------------------|--------|
| Short-Circuit Output Current | I _{O-} | R _L = 10Ω | 95 | 135 | | mA |
| | | | 90 | | | |
| Supply Operating Range | V _{SUPPLY} | V ₊ to V ₋ | 3 | | 5.5 | V |
| EN High Level | V _{ENH} | Referred to V ₋ | 2 | | | V |
| EN Low Level | V _{ENL} | Referred to V ₋ | | | 0.8 | V |
| EN Pin Input High Current | I _{ENH} | V _{EN} = V ₊ | | 0.8 | 1.2 | μA |
| | | | | | 1.4 | |
| EN Pin Input Low Current | I _{ENL} | V _{EN} = V ₋ | | 20 | 80 | nA |
| | | | | | 100 | |
| AC Specifications | | | | | | |
| -3dB Unity Gain Bandwidth | GBW | R _F = 0Ω C _L = 20pF, A _V = 1, R _L = 10kΩ | | 170 | | MHz |
| Total Harmonic Distortion + Noise | THD+N | f = 1kHz, V _{OUT} + 2V _{P-P} , A _V = +1, R _L = 10kΩ | | 0.000 17 | | % |
| 2nd Harmonic Distortion | HD (1MHz) | V _{OUT} = 2V _{P-P} , A _V = 1 | | -87 | | dBc |
| 3rd Harmonic Distortion | | | | -90 | | dBc |
| Off-state Isolation f _O = 100kHz | ISO | A _V = +1; V _{IN} = 100mV _{P-P} ; R _F = 0Ω, C _L = 20pF, A _V = 1, R _L = 10kΩ | | -38 | | dB |
| Channel-to-Channel Crosstalk f _O = 100kHz | X-TALK | V _S = ±2.5V; A _V = +1; V _{IN} = 1V _{P-P} , R _F = 0Ω, C _L = 20pF, A _V = 1, R _L = 10kΩ | | -105 | | dB |
| Power Supply Rejection Ratio f _O = 100kHz | PSRR | V _S = ±2.5V; A _V = +1; V _{SOURCE} = 1V _{P-P} , R _F = 0Ω, C _L = 20pF, A _V = 1, R _L = 10kΩ | | -70 | | dB |
| Common Mode Rejection Ratio f _O = 100kHz | CMRR | V _S = ±2.5V; A _V = +1; V _{CM} = 1V _{P-P} , R _F = 0Ω, C _L = 20pF, A _V = 1, R _L = 10kΩ | | -65 | | dB |
| Input Referred Voltage Noise | e _n | f _O = 1kHz | | 1 | | nV/√Hz |
| Input Referred Current Noise | i _n | f _O = 10kHz | | 2.1 | | pA/√Hz |
| Transient Response | | | | | | |
| Slew Rate | SR | | 30 | 50 | | V/μs |
| | | | 25 | | | |
| Propagation Delay 10% V _{IN} - 10% V _{OUT} | t _{pd} | A _V = 1, V _{OUT} = 100mV _{P-P} , R _F = 0Ω, C _L = 1.2pF | | 1.0 | | ns |
| Rise Time, t _r 10% to 90% | t _r , t _f , Small Signal | A _V = +1, V _{OUT} = 0.1V _{P-P} , R _F = 0Ω, C _L = 1.2pF | | 3.3 | | ns |
| | | | | 6.3 | | ns |

V₊ = 5.0V, V₋ = GND, R_L = Open, R_F = 1kΩ, A_V = -1 unless otherwise specified. Parameters are per amplifier. Typical values are at V₊ = 5V, T_A = +25°C. Boldface limits apply over the operating temperature range, -40°C to +125°C, temperature data established by characterization.(Cont.)

| Parameter | Symbol | Test Conditions | Min ^[1] | Typ | Max ^[1] | Unit |
|--|--|---|--------------------|-----|--------------------|------|
| Rise Time, t _r 10% to 90% | t _r , t _f Large Signal | A _V = +2, V _{OUT} = 1V _{P-P} , R _F = R _G = 499Ω, R _L = 10kΩ, C _L = 1.2pF | | 44 | | ns |
| Fall Time, t _f 10% to 90% | | | | 51 | | ns |
| Rise Time, t _r 10% to 90% | | A _V = +2, V _{OUT} = 4.7V _{P-P} , R _F = R _G = 499Ω, R _L = 10kΩ, C _L = 1.2pF | | 190 | | ns |
| Fall Time, t _f 10% to 90% | | | | 187 | | ns |
| Settling Time to 0.1% 90% V _{OUT} to 0.1% V _{OUT} | t _s | A _V = 1, V _{OUT} = 1V _{P-P} , R _F = 0Ω, C _L = 1.2pF | | 45 | | ns |
| ENABLE to Output Turn-on Delay Time; 10% \overline{EN} – 10% V _{OUT} | $\overline{t_{EN}}$ | A _V = 1, V _{OUT} = 1VDC, R _L = 10kΩ, C _L = 1.2pF | | 330 | | ns |
| ENABLE to Output Turn-off Delay Time; 10% \overline{EN} – 10% V _{OUT} | | A _V = 1, V _{OUT} = 0VDC, R _L = 10kΩ, C _L = 1.2pF | | 50 | | ns |

- Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.

4. Typical Performance Curves

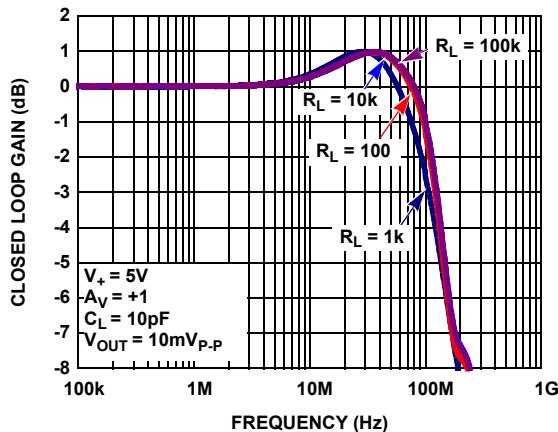
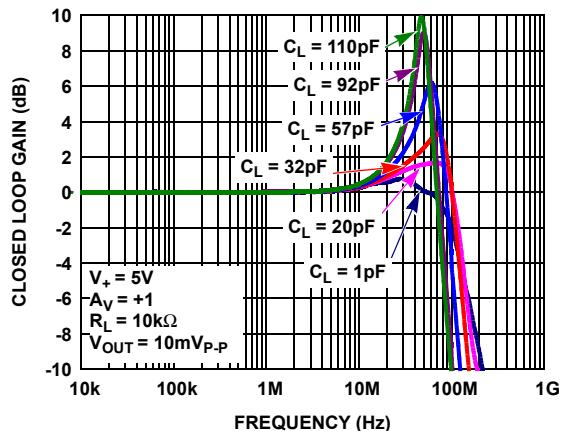
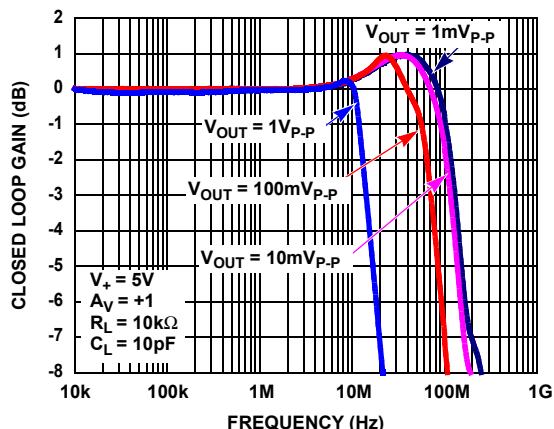
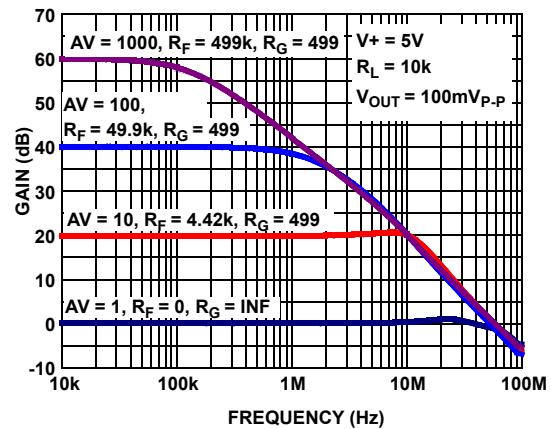
Figure 1. Gain vs Frequency For Various R_{LOAD} Figure 2. Gain vs Frequency For Various C_{LOAD} Figure 3. -3dB Bandwidth vs V_{OUT} 

Figure 4. Frequency Response vs Closed Loop Gain

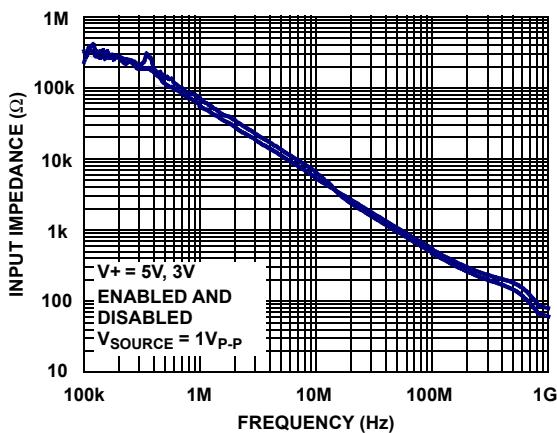


Figure 5. Input Impedance vs Frequency

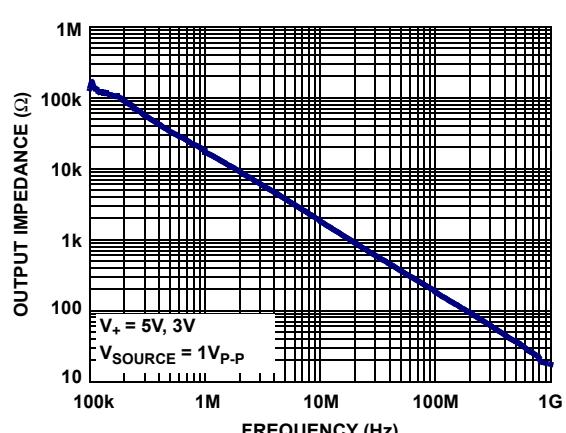


Figure 6. Disabled Output Impedance vs Frequency

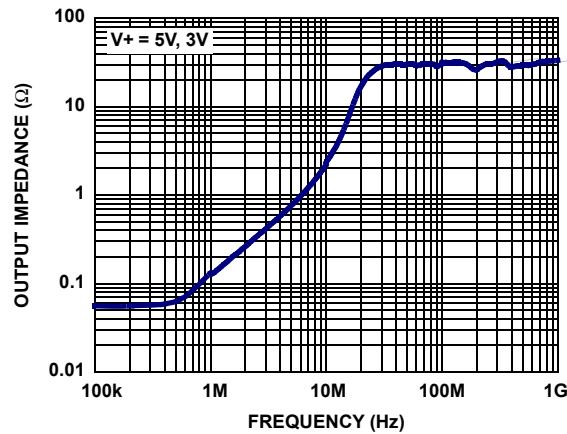


Figure 7. Enabled Output Impedance vs Frequency

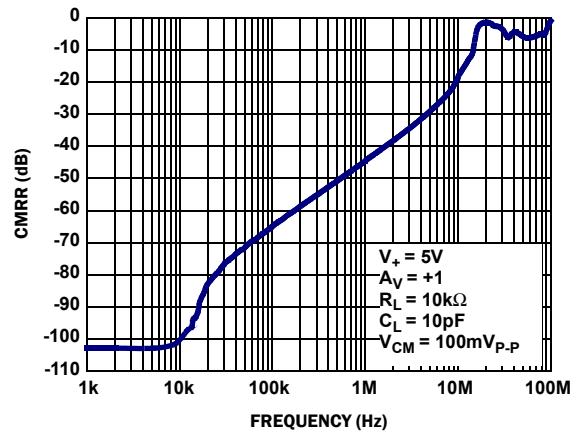


Figure 8. CMRR vs Frequency

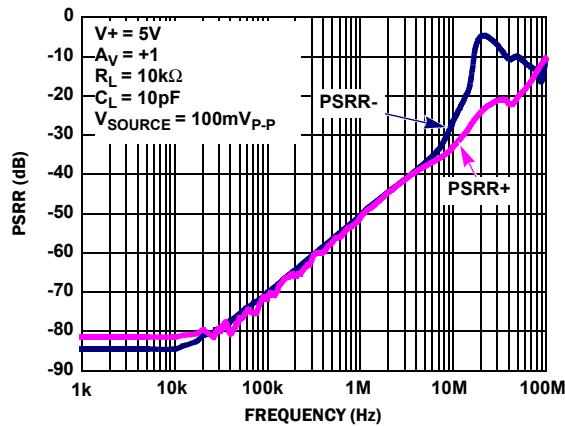


Figure 9. PSRR vs Frequency

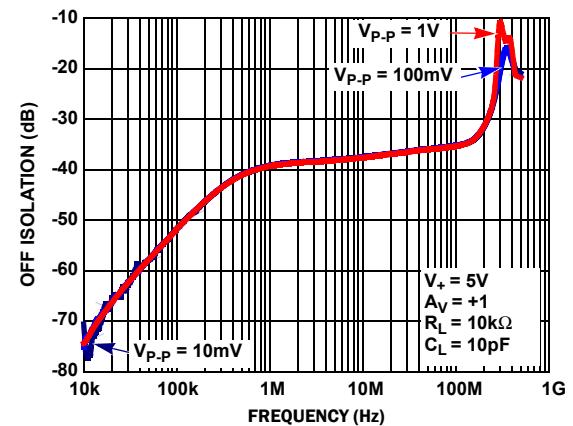


Figure 10. Off Isolation vs Frequency

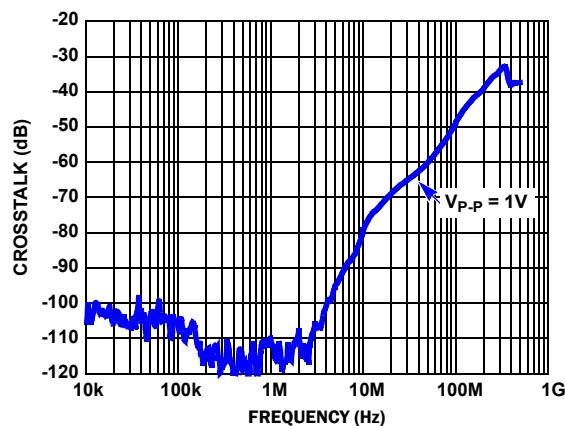


Figure 11. Channel-To-Channel Crosstalk vs Frequency

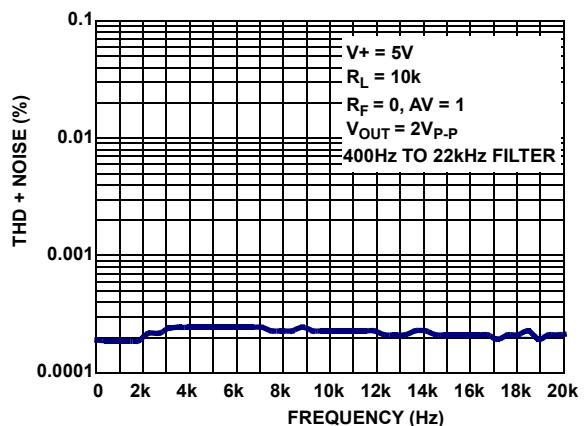


Figure 12. THD+N vs Frequency

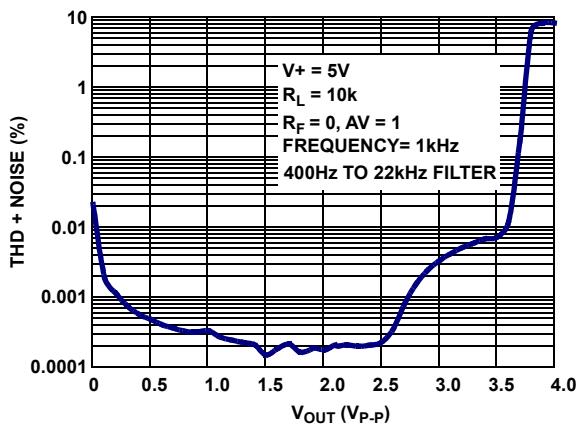
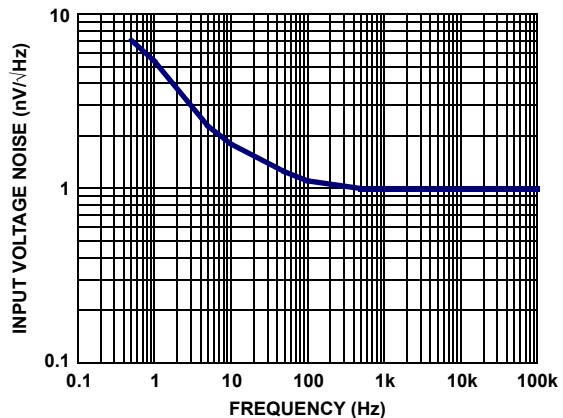
Figure 13. THD+N at 1kHz vs V_{OUT} 

Figure 14. Input Referred Noise Voltage vs Frequency

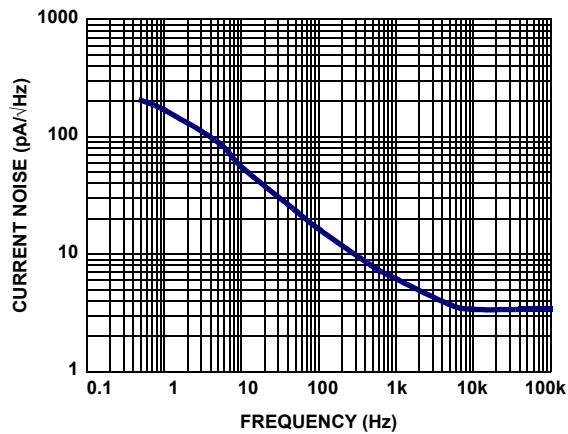


Figure 15. Input Referred Noise Current vs Frequency

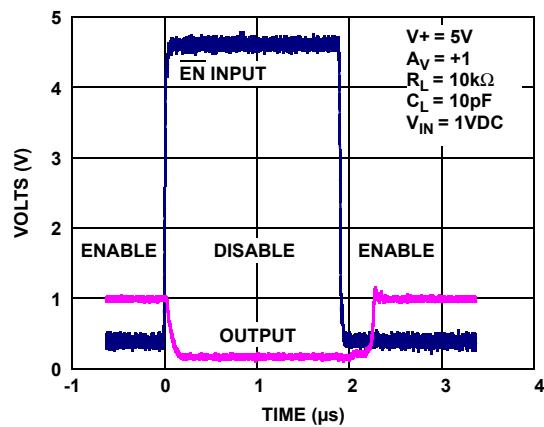


Figure 16. Enable/Disable Timing

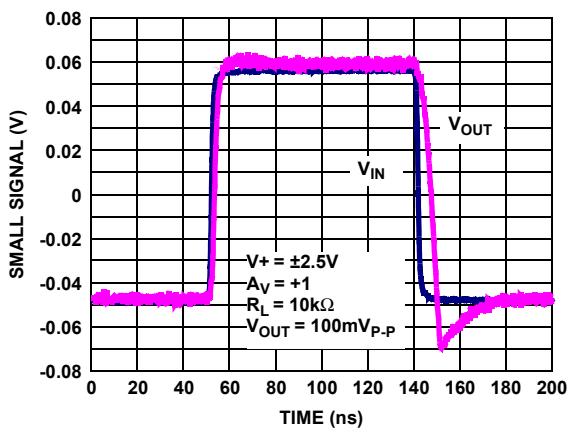


Figure 17. Small Signal Step Response

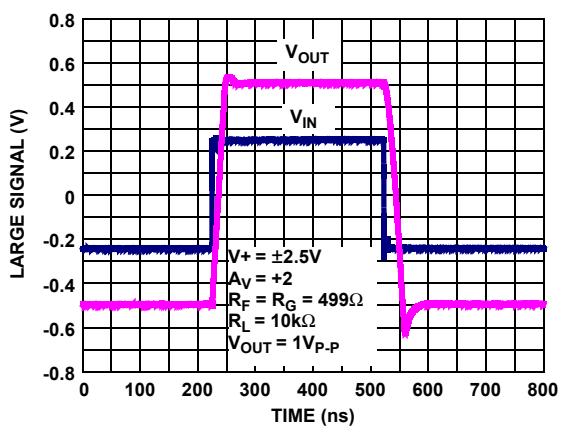
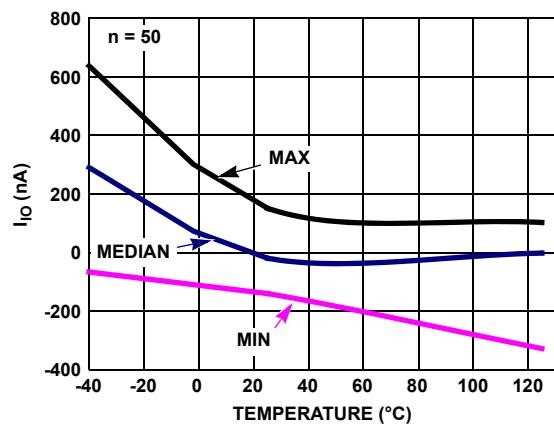
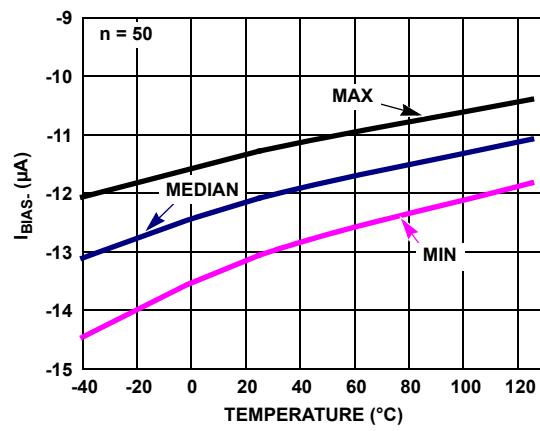
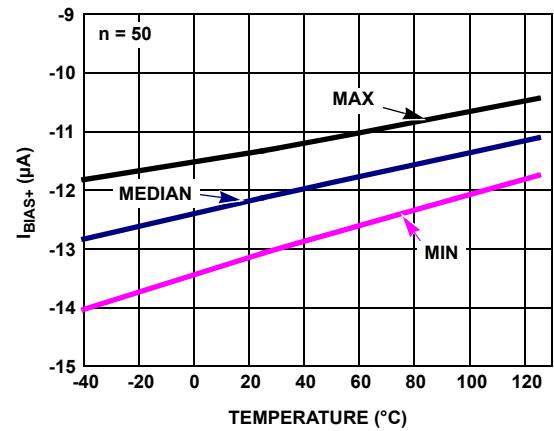
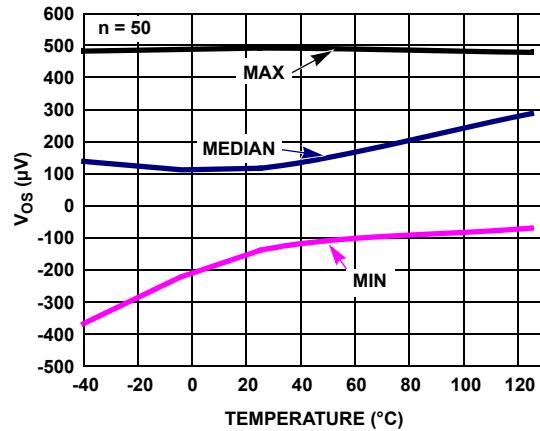
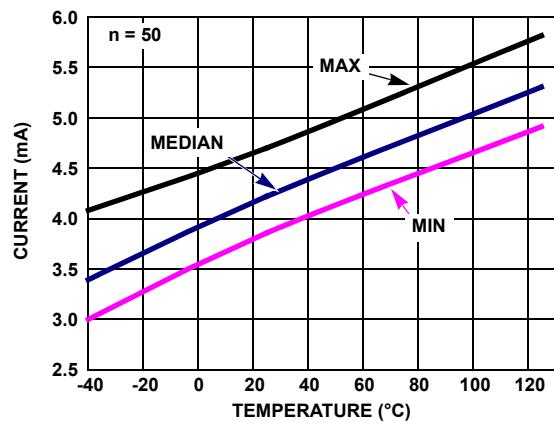
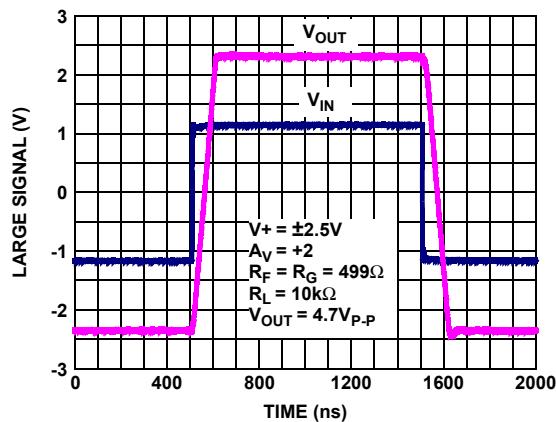


Figure 18. Large Signal (1V) Step Response



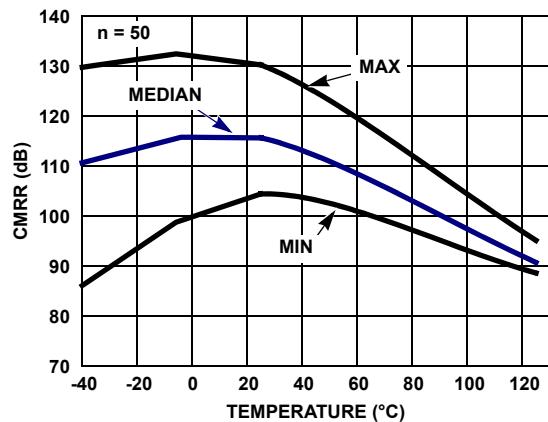


Figure 25. CMRR vs Temperature,
 $V_{CM} = 3.8V$, $V_S = \pm 2.5V$

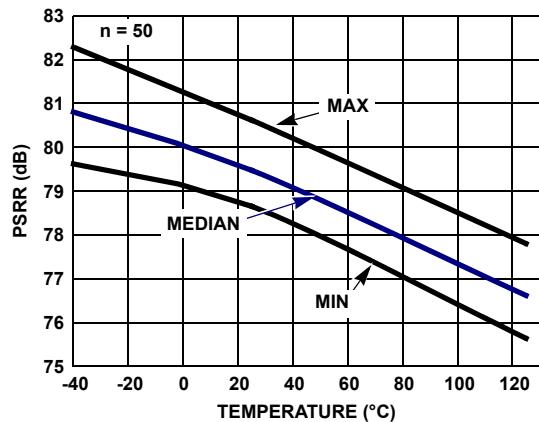


Figure 26. PSRR vs Temperature $\pm 1.5V$ to $\pm 2.5V$

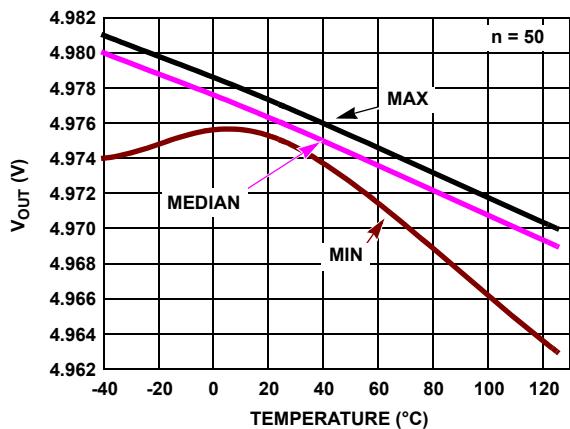


Figure 27. Positive V_{OUT} vs Temperature $RL = 1k$,
 $V_S = \pm 2.5V$

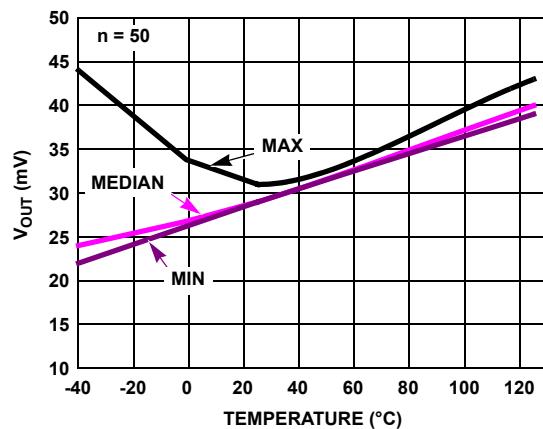


Figure 28. Negative V_{OUT} vs Temperature $RL = 1k$,
 $V_S = \pm 2.5V$

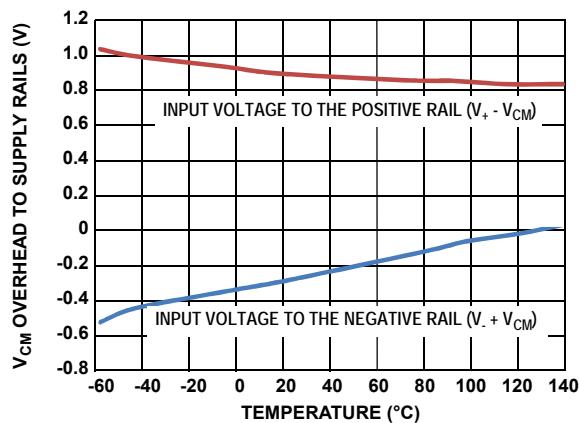


Figure 29. Input Common Mode Voltage vs Temperature

5. Applications Information

5.1 Product Description

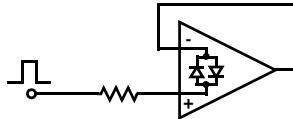
The ISL28290 is a voltage feedback operational amplifier designed for communication and imaging applications requiring low distortion, very low voltage and current noise. The part features high bandwidth while drawing moderately low supply current. The ISL28290 uses a classical voltage-feedback topology, which allows it to be used in a variety of applications where current-feedback amplifiers are not appropriate because of restrictions placed upon the feedback element used with the amplifier.

5.2 Enable/Power-Down

The ISL28290 amplifier is disabled by applying a voltage greater than 2V to the EN pin, with respect to the V- pin. In this condition, the output(s) will be in a high impedance state and the amplifier current will be reduced to 13 μ A/Amp. By disabling the part, multiple parts can be connected together as a MUX. The outputs are tied together in parallel and a channel can be selected by the EN pin. The EN pin also has an internal pull-down. If left open, the EN pin will pull to the negative rail and the device will be enabled by default.

5.3 Input Protection

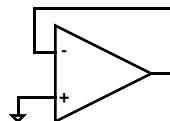
All input terminals have internal ESD protection diodes to both positive and negative supply rails, limiting the input voltage to within one diode beyond the supply rails. The device has additional back-to-back diodes across the input terminals (as shown in [Figure 30](#)). In pulse applications where the input Slew Rate exceeds the Slew Rate of the amplifier, the possibility exists for the input protection diodes to become forward biased. This can cause excessive input current and distortion at the outputs. If overdriving the inputs is necessary, the external input current must never exceed 5mA. An external series resistor may be used to limit the current, as shown in [Figure 30](#).



[Figure 30. Limiting the Input Current to Less Than 5mA](#)

5.4 Using Only One Channel

The ISL28290 is a Dual channel op amp. If the application only requires one channel when using the ISL28290, the user must configure the unused channel to prevent it from oscillating. Oscillation can occur if the input and output pins are floating. This will result in higher than expected supply currents and possible noise injection into the channel being used. The proper way to prevent this oscillation is to short the output to the negative input and ground the positive input (as shown in [Figure 31](#)).



[Figure 31. Preventing Oscillations in Unused Channels](#)

5.5 Power Supply Bypassing and Printed Circuit Board Layout

As with any high frequency device, good printed circuit board layout is necessary for optimum performance. Low impedance ground plane construction is essential. Surface mount components are recommended, but if leaded components are used, lead lengths should be as short as possible. The power supply pins must be well bypassed to reduce the risk of oscillation. The combination of a $4.7\mu F$ tantalum capacitor in parallel with a $0.01\mu F$ capacitor has been shown to work well when placed at each supply pin.

For good AC performance, parasitic capacitance should be kept to a minimum, especially at the inverting input. When ground plane construction is used, it should be removed from the area near the inverting input to minimize any stray capacitance at that node. Carbon or Metal-Film resistors are acceptable with the Metal-Film resistors giving slightly less peaking and bandwidth because of additional series inductance. Use of sockets, particularly for the SO package, should be avoided if possible. Sockets add parasitic inductance and capacitance, which will result in additional peaking and overshoot.

5.6 Current Limiting

The ISL28290 has no internal current-limiting circuitry. If the output is shorted, it is possible to exceed the Absolute Maximum Rating for output current or power dissipation, potentially resulting in the destruction of the device. This is why output short circuit current is specified and tested with $R_L = 10\Omega$.

5.7 Power Dissipation

It is possible to exceed the $+125^\circ C$ maximum junction temperatures under certain load and power-supply conditions. It is therefore important to calculate the maximum junction temperature (T_{JMAX}) for all applications to determine if power supply voltages, load conditions, or package type need to be modified to remain in the safe operating area. These parameters are related as follows:

$$(EQ. 1) \quad T_{JMAX} = T_{MAX} + (\theta_{JA} \times PD_{MAXTOTAL})$$

where:

- $PD_{MAXTOTAL}$ is the sum of the maximum power dissipation of each amplifier in the package (PD_{MAX})
- PD_{MAX} for each amplifier can be calculated as follows:

$$(EQ. 2) \quad PD_{MAX} = 2 \times V_S \times I_{SMAX} + (V_S - V_{OUTMAX}) \times \frac{V_{OUTMAX}}{R_L}$$

- where T_{MAX} = Maximum ambient temperature
- θ_{JA} = Thermal resistance of the package
- PD_{MAX} = Maximum power dissipation of 1 amplifier
- V_S = Supply voltage
- I_{MAX} = Maximum supply current of 1 amplifier
- V_{OUTMAX} = Maximum output voltage swing of the application
- R_L = Load resistance

6. Revision History

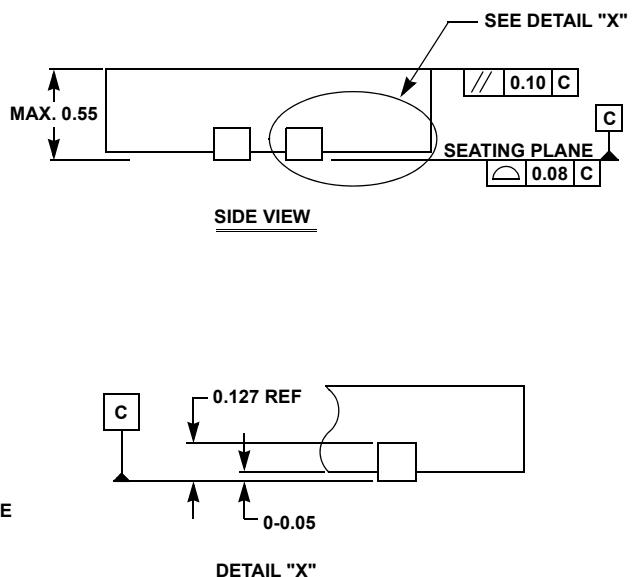
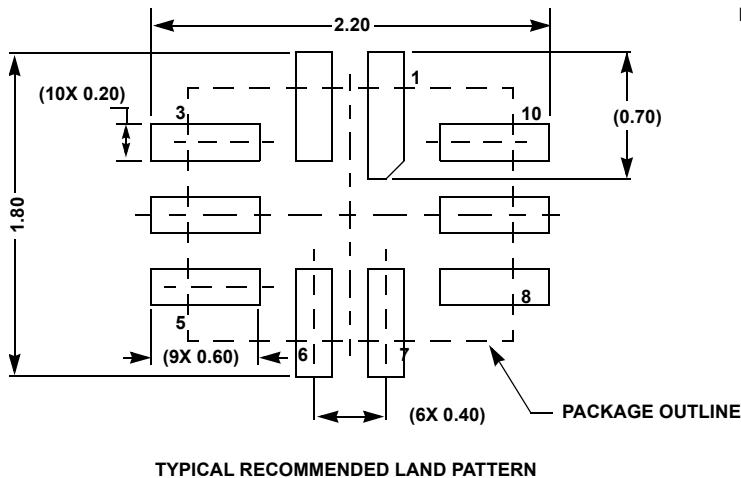
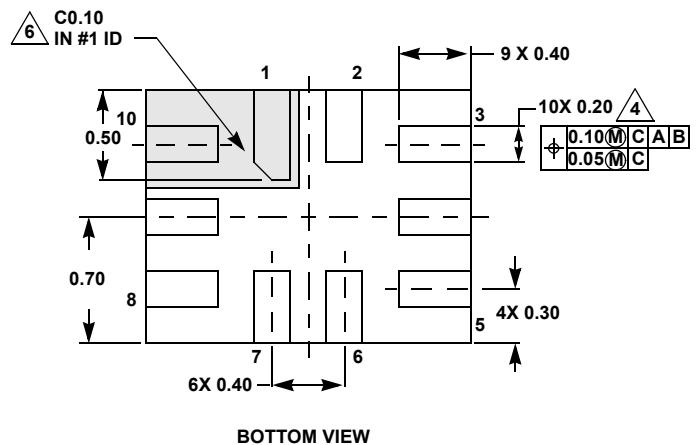
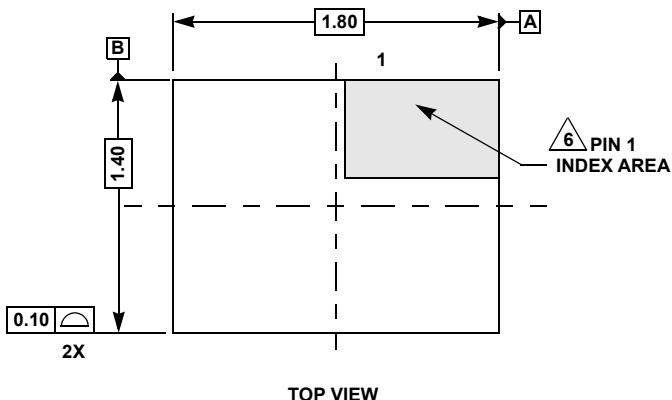
| Rev. | Description | Description |
|-------------|--------------------|---|
| 12.00 | Jan.12.21 | Datasheet formatting overhaul. Removed all references to ISL28190. |

7. Package Outline Drawings

L10.1.8x1.4A

10 Lead Ultra Thin Quad Flat No-lead Plastic Package

Rev 6, 8/13



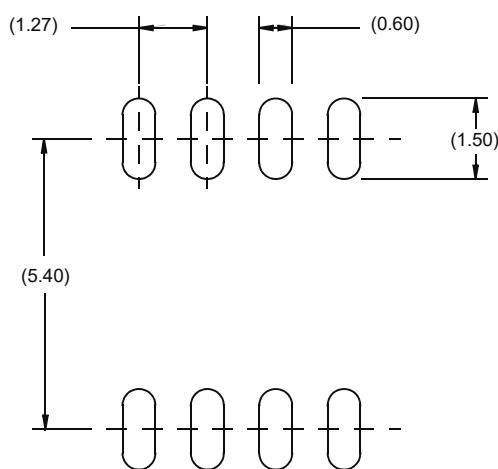
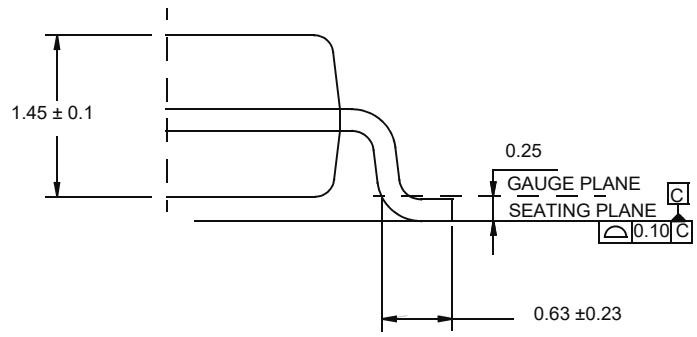
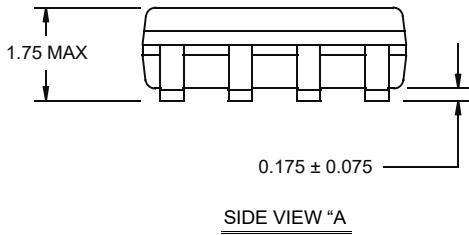
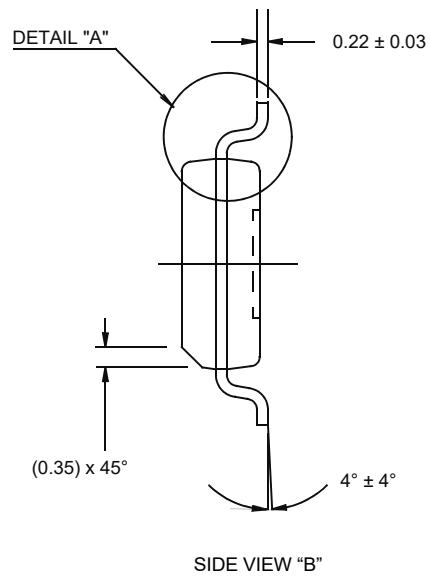
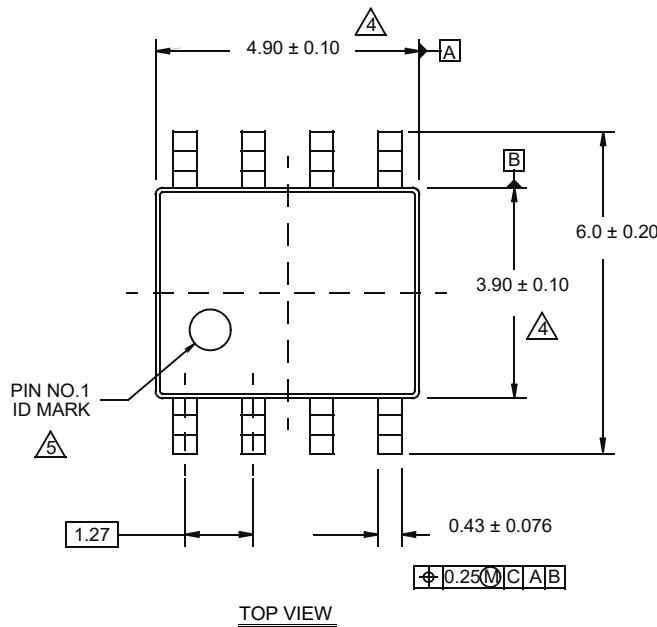
NOTES:

1. Dimensions are in millimeters.
Dimensions in () for Reference Only.
2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal ± 0.05
4. Lead width dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. JEDEC reference MO-255.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

M8.15E

8 Lead Narrow Body Small Outline Plastic Package

Rev 0, 08/09



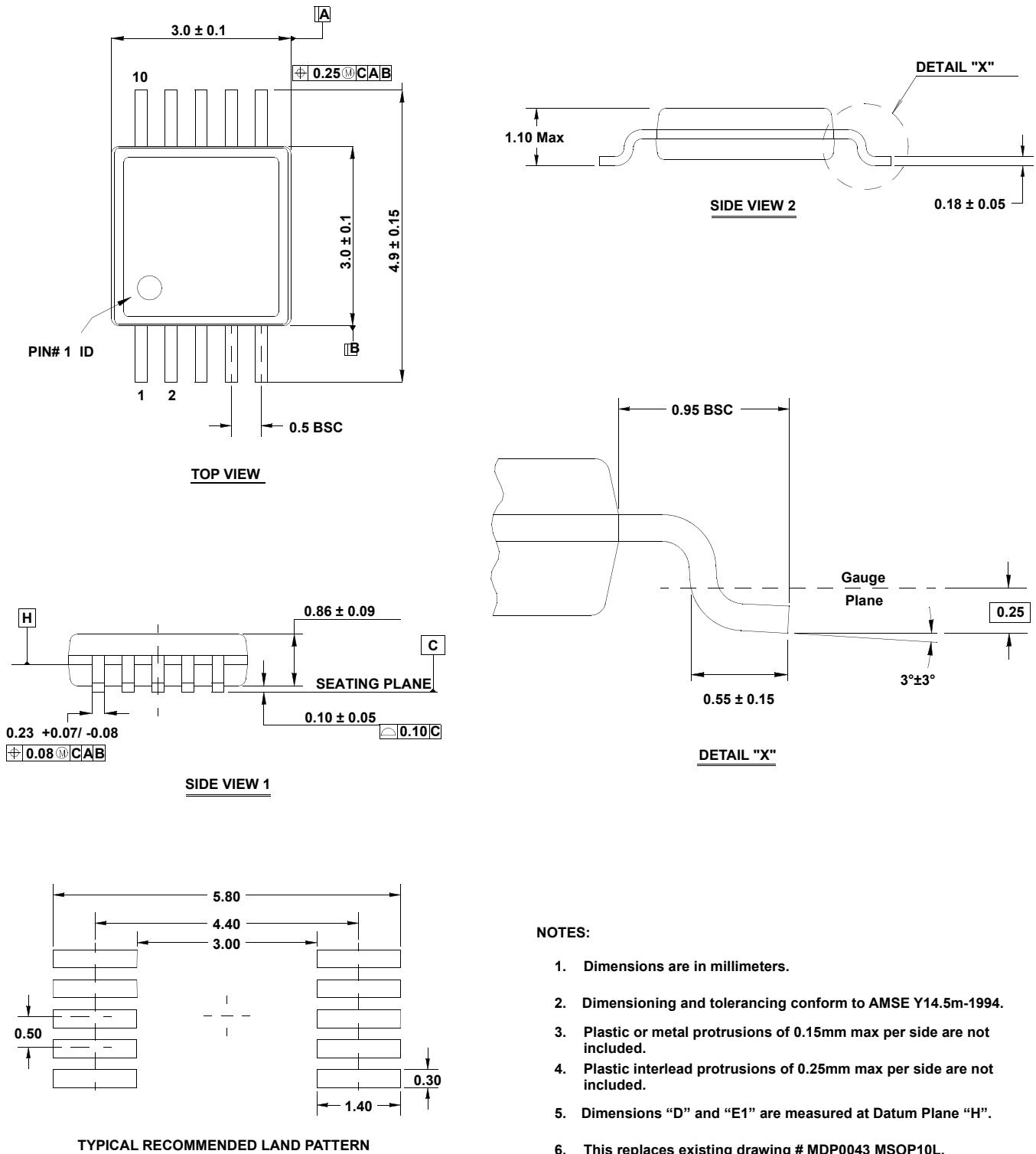
TYPICAL RECOMMENDED LAND PATTERN

NOTES:

1. Dimensions are in millimeters.
Dimensions in () for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal ± 0.05
4. Dimension does not include interlead flash or protrusions.
Interlead flash or protrusions shall not exceed 0.25mm per side.
5. The pin #1 identifier may be either a mold or mark feature.
6. Reference to JEDEC MS-012.

ISL28290 Datasheet

M10.118A (JEDEC MO-187-BA)
10 Lead Mini Small Outline Plastic Package (MSOP)
Rev 0, 9/09



IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:
www.renesas.com/contact/

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.